

## RF power transistor, LdmoST plastic family N-channel enhancement-mode lateral MOSFETs

### Features

- Excellent thermal stability
- Common source configuration
- $P_{OUT} = 35\text{ W}$  with 14.9 dB gain @ 870 MHz / 13.6 V
- Plastic package
- ESD protection
- In compliance with the 2002/95/EC1 European directive

### Description

The PD85035-E is a common source N-channel, enhancement-mode lateral field-effect RF power transistor. It is designed for high gain, broadband commercial and industrial applications. It operates at 13.6 V in common source mode at frequencies of up to 1 GHz. PD85035-E boasts the excellent gain, linearity and reliability of ST's latest LDMOS technology mounted in the first true SMD plastic RF power package, PowerSO-10RF. PD85035-E's superior linearity performance makes it an ideal solution for car mobile radio.

The PowerSO-10 plastic package, designed to offer high reliability, is the first ST JEDEC approved, high power SMD package. It has been specially optimized for RF needs and offers excellent RF performances and ease of assembly. Mounting recommendations are available in [www.st.com/rf/](http://www.st.com/rf/) (look for application note AN1294).

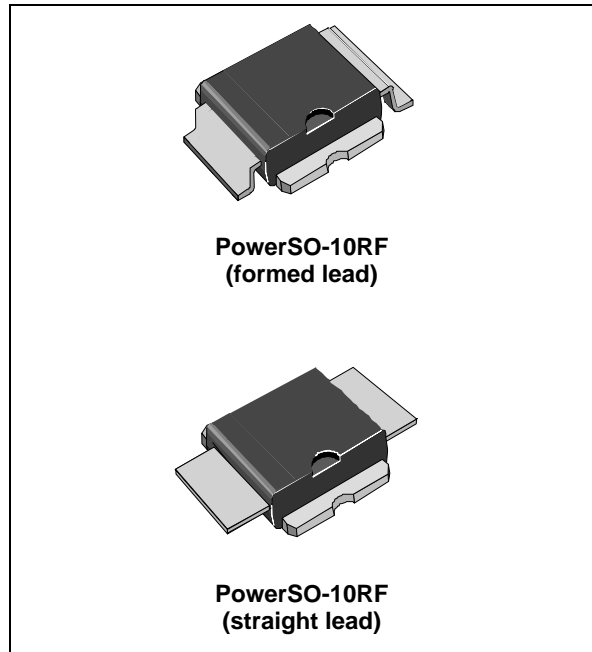


Figure 1. Pin connection

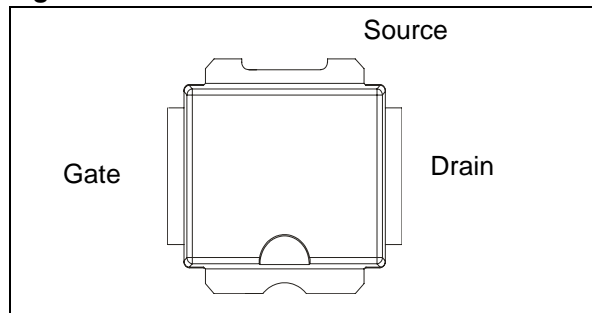


Table 1. Device summary

Order codes	Package	Packing
PD85035-E	PowerSO-10RF (formed lead)	Tube
PD85035S-E	PowerSO-10RF (straight lead)	Tube
PD85035TR-E	PowerSO-10RF (formed lead)	Tape and reel
PD85035STR-E	PowerSO-10RF (straight lead)	Tape and reel

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# 1 Electrical data

## 1.1 Maximum ratings

**Table 2. Absolute maximum ratings** ( $T_{CASE} = 25\text{ °C}$ )

Symbol	Parameter	Value	Unit
$V_{(BR)DSS}$	Drain-source voltage	40	V
$V_{GS}$	Gate-source voltage	-0.5 to +15	V
$I_D$	Drain current	8	A
$P_{DISS}$	Power dissipation (@ $T_C = 70\text{ °C}$ )	95	W
$T_J$	Max. operating junction temperature	165	°C
$T_{STG}$	Storage temperature	-65 to +150	°C

## 1.2 Thermal data

**Table 3. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thJC}$	Junction - case thermal resistance	1.0	°C/W

## 2 Electrical characteristics

$T_{CASE} = +25\text{ }^{\circ}\text{C}$

### 2.1 Static

**Table 4. Static**

Symbol	Test conditions		Min	Typ	Max	Unit
$I_{DSS}$	$V_{GS} = 0\text{ V}$	$V_{DS} = 25\text{ V}$			1	$\mu\text{A}$
$I_{GSS}$	$V_{GS} = 5\text{ V}$	$V_{DS} = 0\text{ V}$			1	$\mu\text{A}$
$V_{GS(Q)}$	$V_{DS} = 10\text{ V}$	$I_D = 250\text{ mA}$	3.4		4.6	V
$V_{DS(ON)}$	$V_{GS} = 10\text{ V}$	$I_D = 3\text{ A}$		0.64	0.7	V
$C_{ISS}$	$V_{GS} = 0\text{ V}$	$V_{DS} = 12.5\text{ V}$		f = 1 MHz 76		pF
$C_{OSS}$	$V_{GS} = 0\text{ V}$	$V_{DS} = 12.5\text{ V}$		f = 1 MHz 45		pF
$C_{RSS}$	$V_{GS} = 0\text{ V}$	$V_{DS} = 12.5\text{ V}$		f = 1 MHz 1.4		pF

### 2.2 Dynamic

**Table 5. Dynamic**

Symbol	Test conditions		Min	Typ	Max	Unit
P3dB	$V_{DD} = 13.6\text{ V}$ , $I_{DQ} = 350\text{ mA}$	f = 870 MHz	35	40		W
$G_P$	$V_{DD} = 13.6\text{ V}$ , $I_{DQ} = 350\text{ mA}$ , $P_{OUT} = 15\text{ W}$ , f = 870 MHz		15	17		dB
$h_D$	$V_{DD} = 13.6\text{ V}$ , $I_{DQ} = 350\text{ mA}$ , $P_{OUT} = P_{3dB}$ , f = 870 MHz		60	72		%
Load mismatch	$V_{DD} = 1\text{ 7V}$ , $I_{DQ} = 350\text{ mA}$ , $P_{OUT} = 50\text{ W}$ , f = 870 MHz All phase angles		20:1			VSWR

### 2.3 ESD protection characteristics

**Table 6. ESD protection characteristics**

Test conditions	Class
Human body model	2
Machine model	M3

### 2.4 Moisture sensitivity level

**Table 7. Moisture sensitivity level**

Test methodology	Rating
J-STD-020B	MSL 3

### 3 Impedance

Figure 2. Current conventions

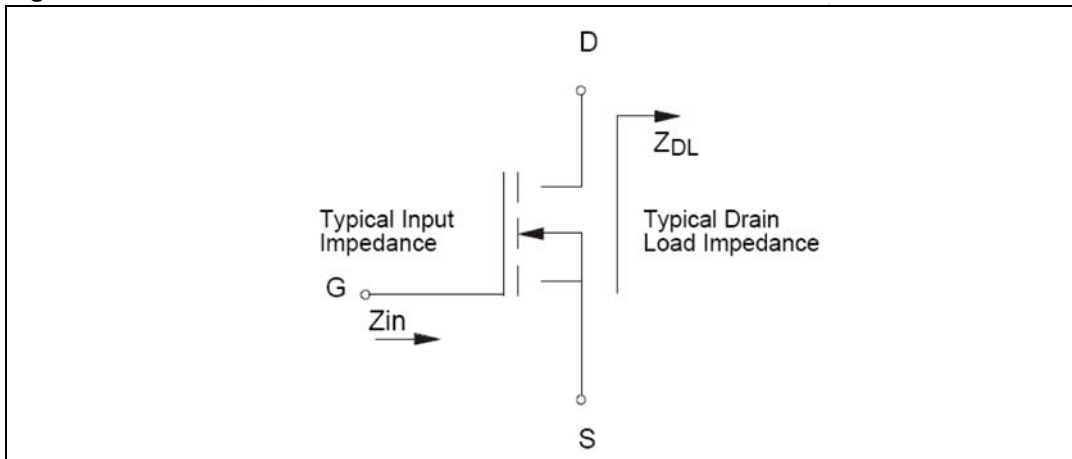


Table 8. Impedance data

Frequency (MHz)	$Z_{IN} (\Omega)$	$Z_{DL}(\Omega)$
870 MHz	$0.57 + j 0.73$	$1.73 - j 0.15$

# 4 Typical performance

Figure 3. Threshold voltage

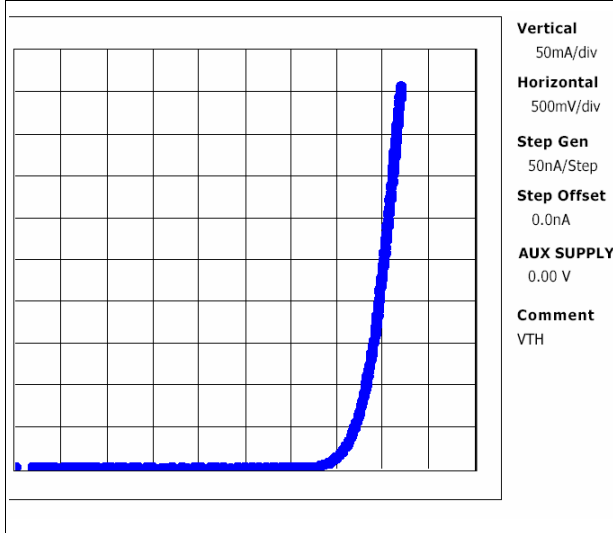


Figure 4. DC output characteristic

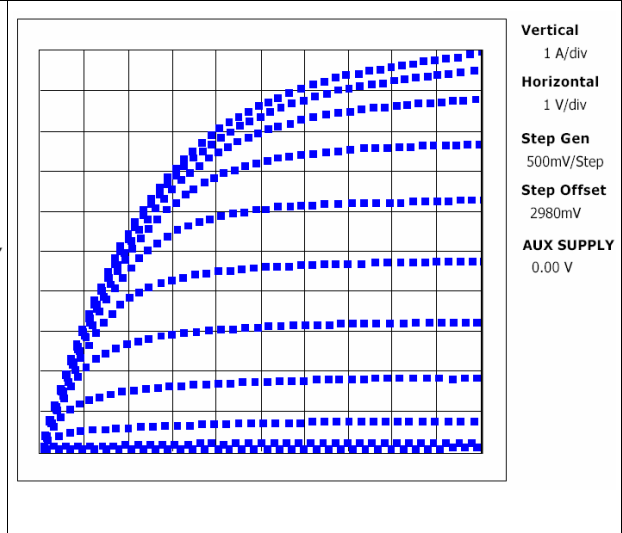


Figure 5.  $I_D$  vs  $V_{GS}$

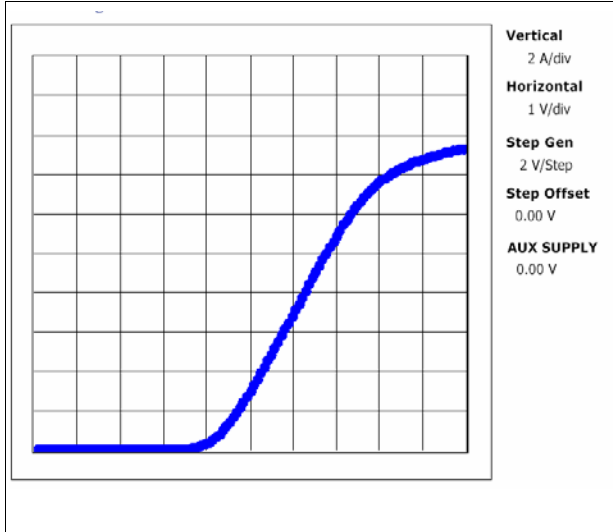


Figure 6. Capacitances vs voltage

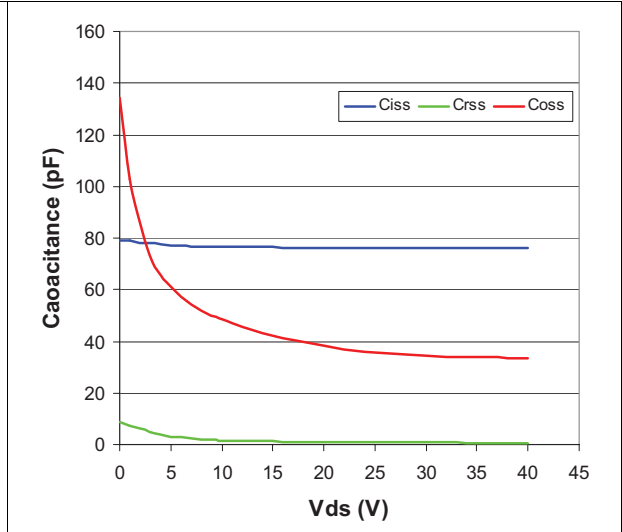


Figure 7. Pout and Id vs VGS

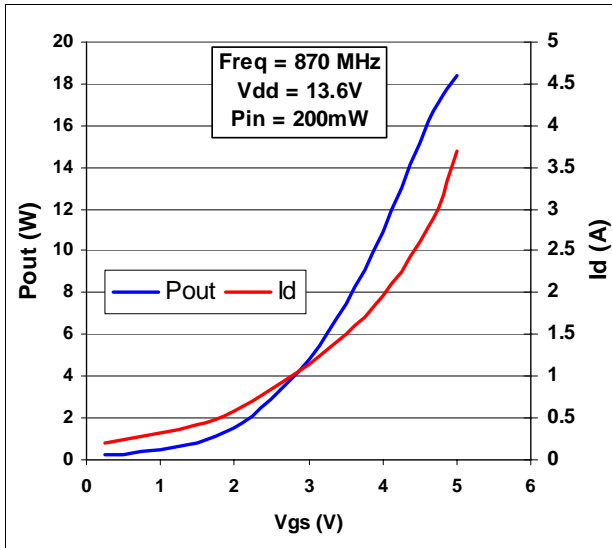


Figure 8. Pout and Id vs VGS

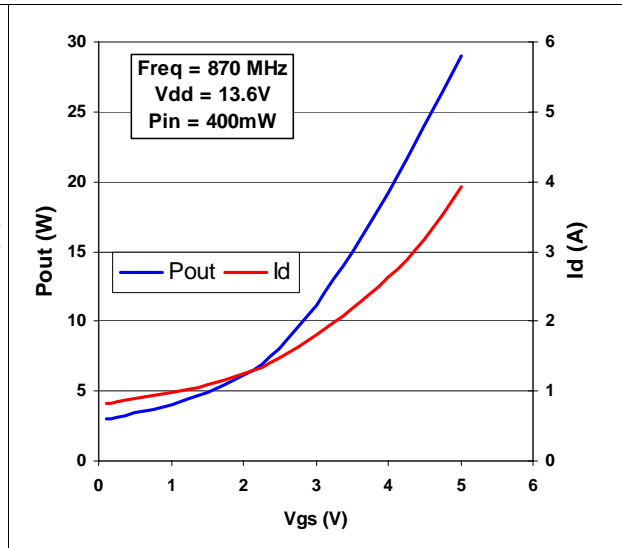


Figure 9. Gain vs Pout and bias current

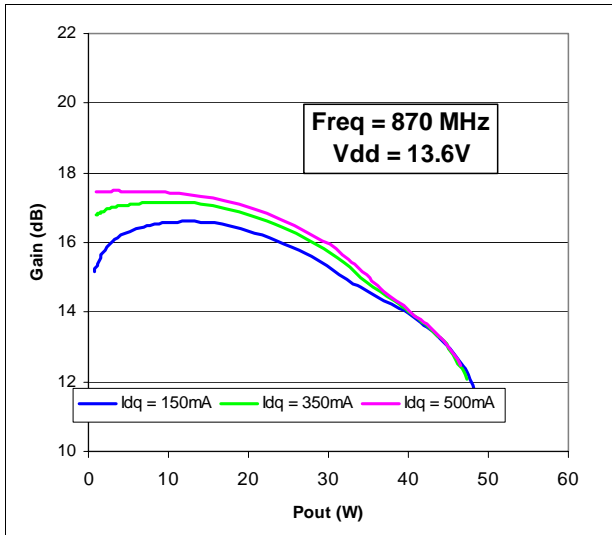


Figure 10. Gain and efficiency vs Pout

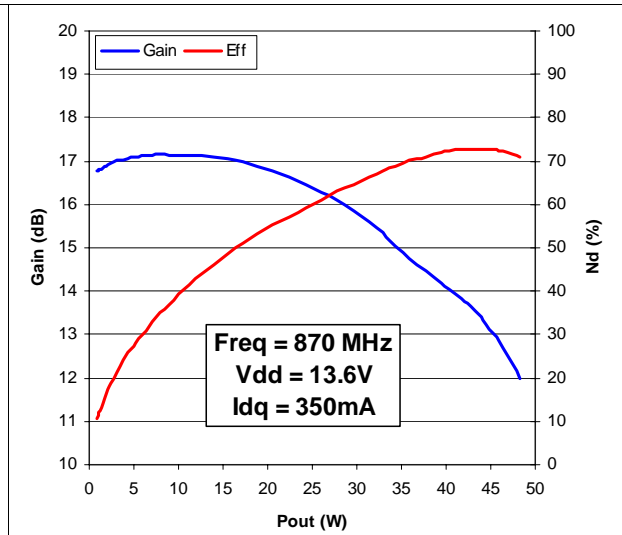


Figure 11. Pout and Id vs supply voltage

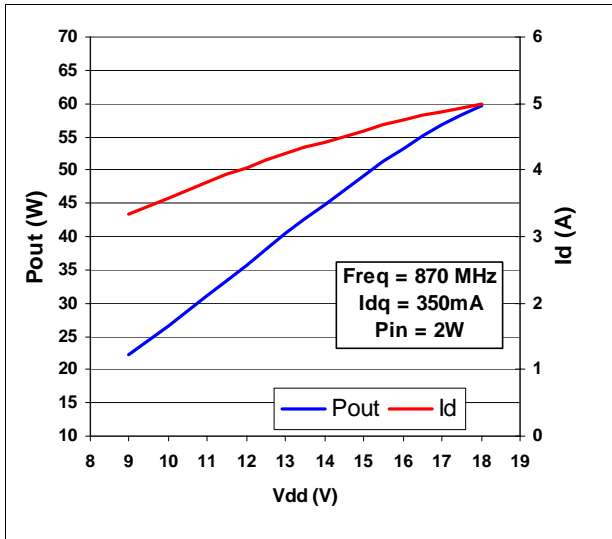
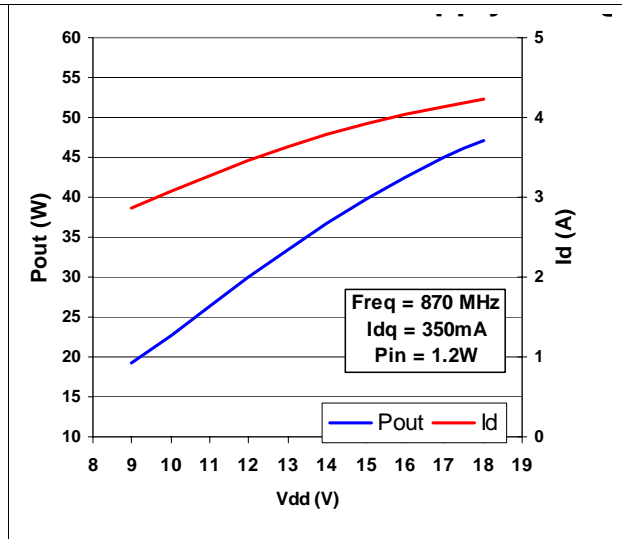


Figure 12. Pout and Id vs supply voltage





## 5 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

**Table 9. PowerSO-10RF formed lead (gull wing) mechanical data**

Dim.	mm.			Inch		
	Min	Typ	Max	Min	Typ	Max
A1	0	0.05	0.1	0.	0.0019	0.0038
A2	3.4	3.5	3.6	0.134	0.137	0.142
A3	1.2	1.3	1.4	0.046	0.05	0.054
A4	0.15	0.2	0.25	0.005	0.007	0.009
a		0.2			0.007	
b	5.4	5.53	5.65	0.212	0.217	0.221
c	0.23	0.27	0.32	0.008	0.01	0.012
D	9.4	9.5	9.6	0.370	0.374	0.377
D1	7.4	7.5	7.6	0.290	0.295	0.298
E	13.85	14.1	14.35	0.544	0.555	0.565
E1	9.3	9.4	9.5	0.365	0.37	0.375
E2	7.3	7.4	7.5	0.286	0.292	0.294
E3	5.9	6.1	6.3	0.231	0.24	0.247
F		0.5			0.019	
G		1.2			0.047	
L	0.8	1	1.1	0.030	0.039	0.042
R1			0.25			0.01
R2		0.8			0.031	
T	2 deg	5 deg	8 deg	2 deg	5 deg	8 deg
T1		6 deg			6 deg	
T2		10 deg			10 deg	

*Note: Resin protrusions not included (max value: 0.15 mm per side)*

Figure 13. Package dimensions

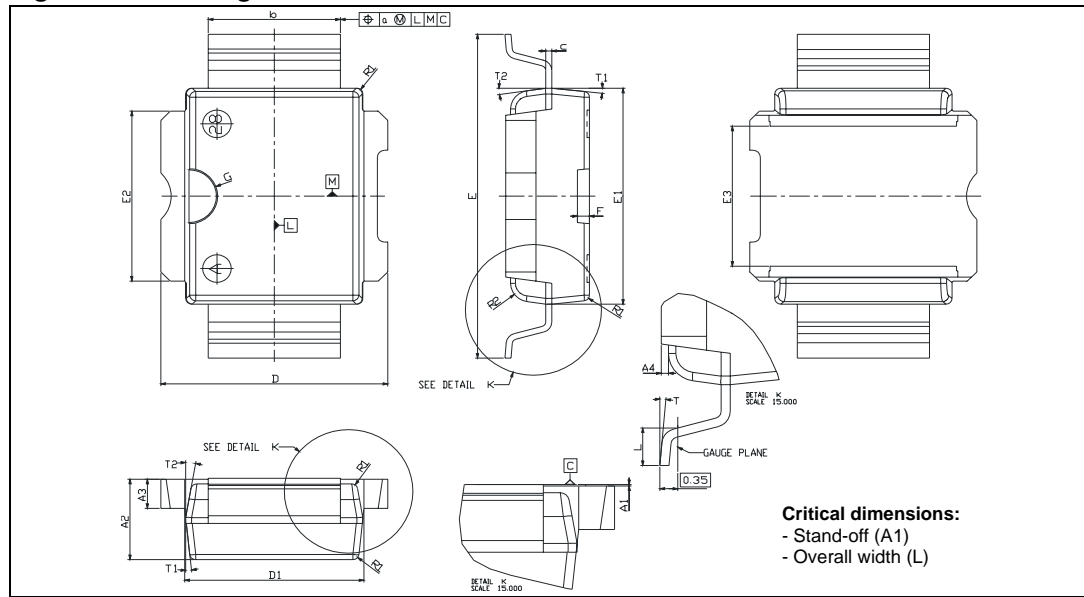


Table 10. PowerSO-10RF straight lead mechanical data

Dim.	mm.			Inch		
	Min	Typ	Max	Min	Typ	Max
A1	1.62	1.67	1.72	0.064	0.065	0.068
A2	3.4	3.5	3.6	0.134	0.137	0.142
A3	1.2	1.3	1.4	0.046	0.05	0.054
A4	0.15	0.2	0.25	0.005	0.007	0.009
a		0.2			0.007	
b	5.4	5.53	5.65	0.212	0.217	0.221
c	0.23	0.27	0.32	0.008	0.01	0.012
D	9.4	9.5	9.6	0.370	0.374	0.377
D1	7.4	7.5	7.6	0.290	0.295	0.298
E	15.15	15.4	15.65	0.595	0.606	0.615
E1	9.3	9.4	9.5	0.365	0.37	0.375
E2	7.3	7.4	7.5	0.286	0.292	0.294
E3	5.9	6.1	6.3	0.231	0.24	0.247
F		0.5			0.019	
G		1.2			0.047	
R1			0.25			0.01
R2		0.8			0.031	
T1		6 deg			6 deg	
T2		10 deg			10 deg	

Note: Resin protrusions not included (max value: 0.15 mm per side)

Figure 14. Package dimensions

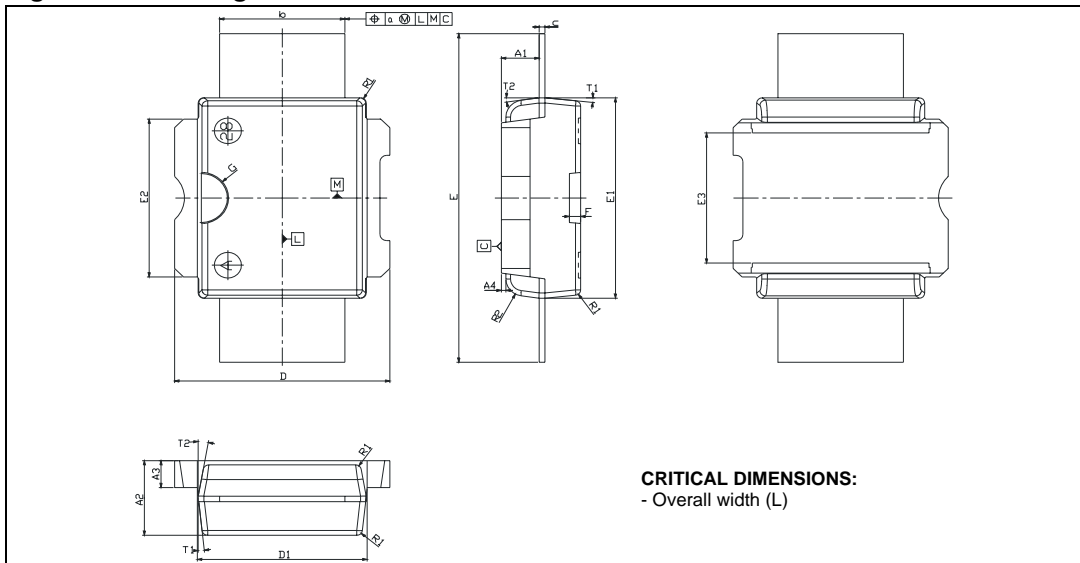


Figure 15. Tube information

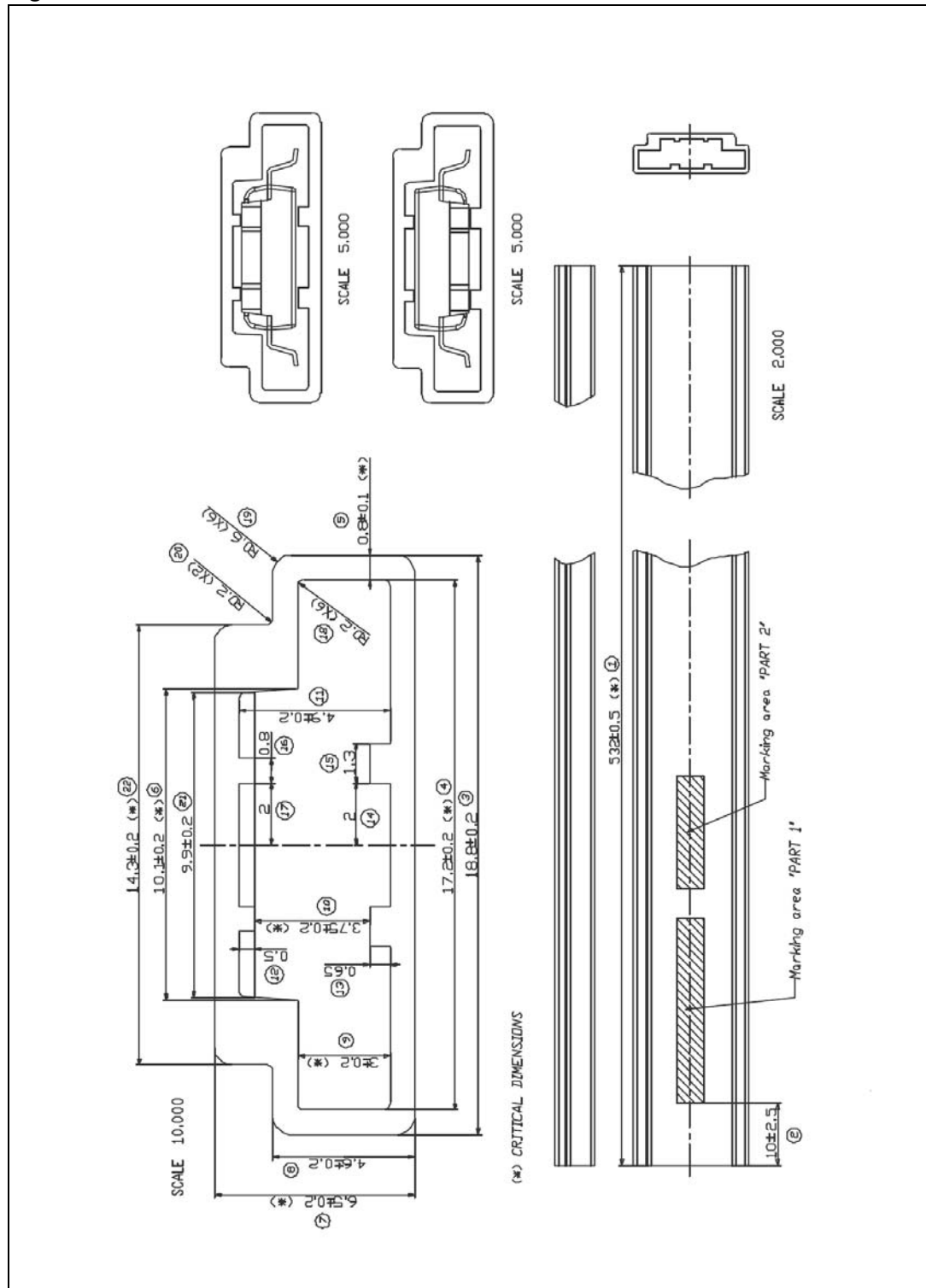
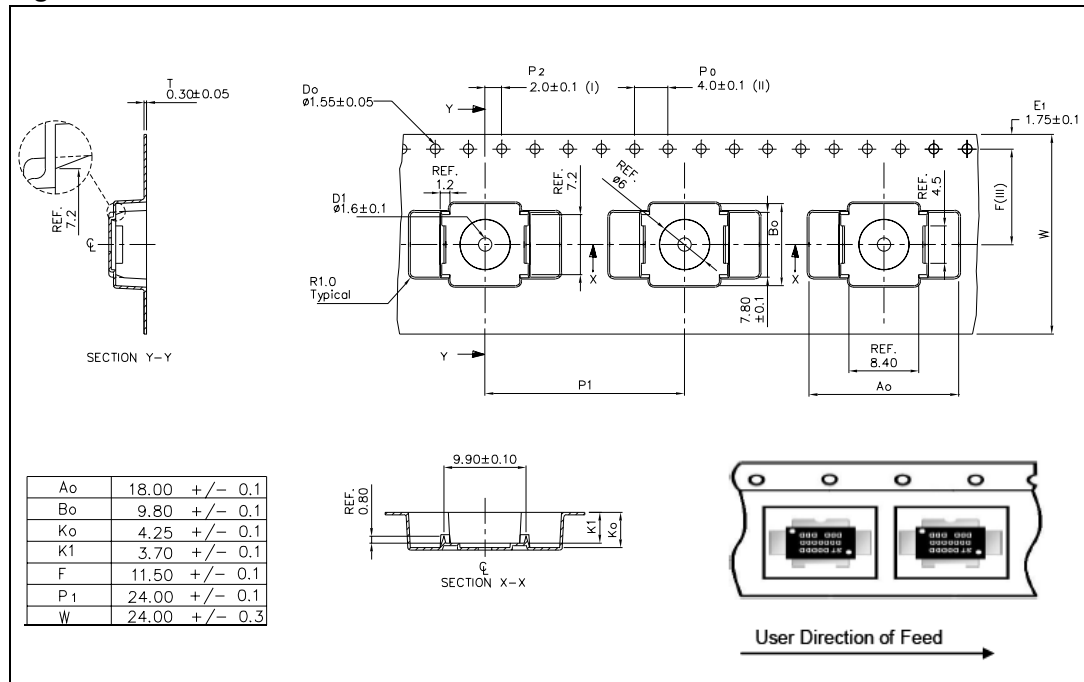


Figure 16. Reel information



## 6 Revision history

**Table 11. Document revision history**

Date	Revision	Changes
16-May-2007	1	Initial release.
26-Aug-2008	2	Updated <a href="#">Table 4 on page 4</a> .
04-May-2011	3	Updated <a href="#">Table 4 on page 4</a> and <a href="#">Figure 16: Reel information</a> .

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